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1/4-inch 2 MP CMOS Digital Image Sensor

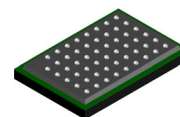
AR0246

General Description

The onsemi AR0246 is a stacked 1/4-inch back side illuminated (BSI) CMOS active-pixel digital image sensor with a pixel array of 1920 (H) x 1080 (V). The sensor has enhanced NIR response. It captures images in either linear or high dynamic range modes with a rolling shutter readout, and includes sophisticated camera functions such as binning, windowing and both video and single frame modes. It is designed for both low light and high dynamic range performance. AR0246 can combine on chip up to three exposures and compand to 12-bit HDR output (eHDR) or it could provide line interleaved output of two exposures to support off chip HDR (LI HDR) in an ISP chip. It could also provide enhanced Dynamic Range (eDR) from single exposure. The AR0246 produces extraordinarily clear, sharp digital pictures, and its ability to capture both continuous video and single frame enhanced NIR response makes it the perfect choice for security applications.

Table 1. KEY PERFORMANCE PARAMETERS

Parameter	Typical Value
Optical Format	1/4-inch (4.41 mm Diagonal, 16:9)
Active Pixels	1920 (H) x 1080 (V)
Pixel Size	2.0 μm x 2.0 μm , BSI
Color Filter Array	RGB
Chief Ray Angle	10°, 32°
Shutter Type	ERS and GRR
One-Time Programmable Memory (OTPM)	160 Bytes
Input Clock Range	6 ~ 48 MHz
Output Interface	2-lane MIPI (2 lanes, 1 Gbps/lane)
ADC Resolution	12-bit on die
Global Gain Range	0 dB to 42 dB (in steps of 0.375 dB)
Analog Gain:	0-18 dB
Digital Gain:	18-42 dB
Frame Rate	Linear: 1080p @ 60 fps LI-HDR (2exp): 1080p@ 30 fps eHDR (3 exp): 1080p @ 30 fps eDR (1 exp): 1080p @ 30 fps
Subsampling	Bin2, skip2
Multi-camera Support	Frame Rate and Exposure Synchronization
Responsivity	18 ke-/lux*s
SNR _{MAX}	39 dB
Dynamic Range	80 dB – eDR Mode Dynamic Range 120 dB – eHDR Mode Dynamic Range 96 dB – LI-HDR Mode Dynamic Range



ODCSP53
CASE 570AA

Non-NDA Data Sheet

Interested in what you see? If you would like more detailed information, please request the full version of our data sheet.

[Request Full Data Sheet](#)

Features

- 1080p (1920 x 1080, Full Resolution of 2 MP) at 60 fps Linear Mode Video Capture
- Full Resolution at 30 fps, 3-exposure embedded High Dynamic Range (eHDR) Video Capture with Exposure Ratio Control
- Full Resolution at 45 fps, enhanced Dynamic Range (eDR) Video Capture for enhanced Dynamic Range from Single Exposure with No Motion Artifacts from Multiple Exposures
 - ◆ Full Resolution at 30 fps, 2-exposure Line Interleaved enhanced Dynamic Range (LI-eDR) Video Capture
- Full Resolution at 30 fps, 2-exposure Line Interleave HDR (LI-HDR) Video Capture. T1/T2 Readout to Enable HDR Processing in ISP Chip
- Adaptive Local Tone Mapping (ALTM) Supported to Compress High Dynamic Range Image to Available Display Device Range
- Super Low Power Mode (SLP)
- Wake on Motion (WOM)/Motion Detection
 - ◆ Motion Detection, Auto Wake Up from Standby Mode (240 x 135 full Resolution)
- Context Switching
- Electronic Rolling Shutter (ERS) and Global Reset Release (GRR) Modes Supported
- Triggered Integration and Readout Control

Table 1. KEY PERFORMANCE PARAMETERS

Parameter	Typical Value
Supply Voltage I/O	1.8 V (1.7 V < V _{supply} < 1.9 V) or 2.8 V (2.7 V < V _{supply} < 2.9 V)
Digital	1.05 V (1 V < V _{supply} < 1.1 V)
Analog	2.8 V (2.7 V < V _{supply} < 2.9 V)
Power Consumption (Typical)	Linear 60 fps: 180 mW (Note 1) eHDR 30 fps: 281 mW (Note 1)
Operating Temperature	(−30°C < T _J < +85°C)
Optimal Performance Temperature	(0°C < T _J < +60°C)
Package Options	5.31 mm x 3.61 mm 53-pin CSP package Bare Die
θ _{JA} (Note 2)	41.65°C/W (Note 2)
θ _{JB}	13.45°C/W

1. Power consumption numbers are estimated values.
2. θ_{JA} is dependent on the customer module design and should not be used for calculating junction temperature.

Applications

- Security
- IoT
- Car DVR

Table 2. 12-bit MODE OF OPERATION AND POWER

Mode Name	Mode Description	Resolution	Frame Rate
Native	1080p Linear	1920 x 1080	60
Native	1080p Linear, Lower Frame Rate	1920 x 1080	30
eHDR Native	1080p eHDR 2exp	1920 x 1080	45
eHDR 3exp Native	1080p eHDR 3exp	1920 x 1080	30
eHDR 3exp ALTM Native	1080p eHDR 3exp ALTM	1920 x 1080	30
LI Native	1080p LI-HDR 2exp	1920 x 1080	30
WoM bin4skip2 (Note 3)	Wake on Motion w/ Streaming	240 x 135	1
Bin2	0.5 MP Linear	960 x 540	180
eDR Native	1080p eDR	1920 x 1080	45
eDR ALTM Native	1080p eDR ALTM	1920 x 1080	45
LI-eDR Native	1080p LI-eDR	1920 x 1080	30
SLP Native	1080p SLP	1920 x 1080	1

3. Actual resolution of sensor is 480 x 135 with every alternate col being dummy pixel output, active resolution is 240 x 135.

AR0246

Table 3. ORDERING INFORMATION

Part Number	Product Description				Orderable Product Attribute Description
AR0246NPSC10SMKA1-CP	2 MP	RGB	10° CRA	Production Part	Chip Tray with Protective Film
AR0246NPSC10SMKA1-CP2	2 MP	RGB	10° CRA	Production Part	Chip Tray with Protective Film Low MOQ
AR0246NPSC10SMKA1-CR	2 MP	RGB	10° CRA	Production Part	Chip Tray without Protective Film

AR0246NPSC32SMKA1-CP	2 MP	RGB	32° CRA	Production Part	Chip Tray with Protective Film
AR0246NPSC32SMKA1-CP2	2 MP	RGB	32° CRA	Production Part	Chip Tray with Protective Film Low MOQ
AR0246NPSC32SMKA1-CR	2 MP	RGB	32° CRA	Production Part	Chip Tray without Protective Film

AR0246NPSC10SMKAH3-GEVB	2 MP	RGB	10° CRA		Demo Headboard
AR0246NPSC32SMKAH3-GEVB	2 MP	RGB	32° CRA		Demo Headboard

NOTE: Refer to AR0246 Die Data Sheet for Die Part Numbers & Ordering Information.

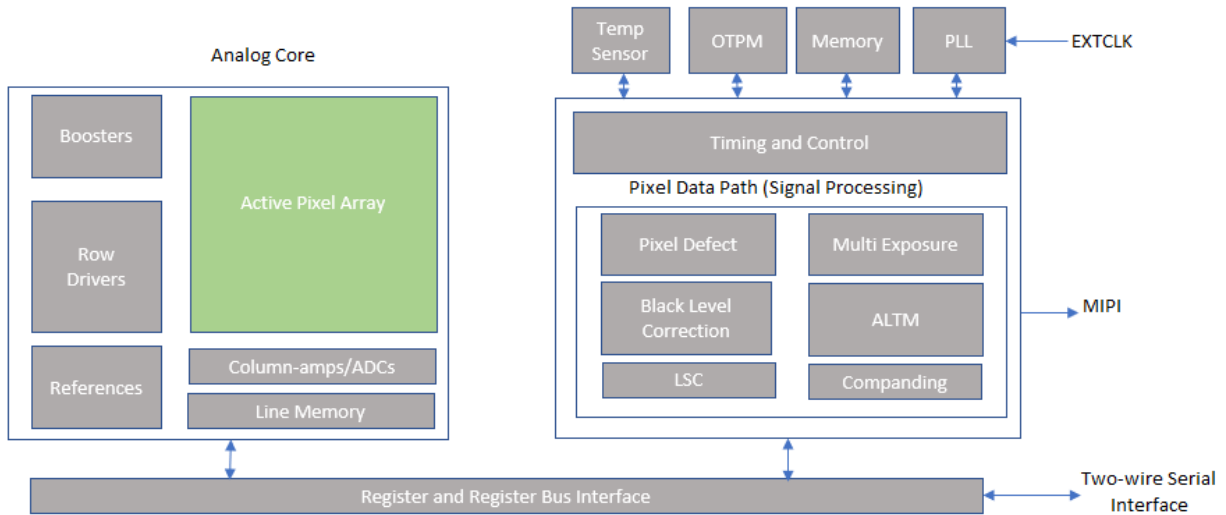
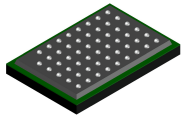


Figure 1. Block Diagram

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

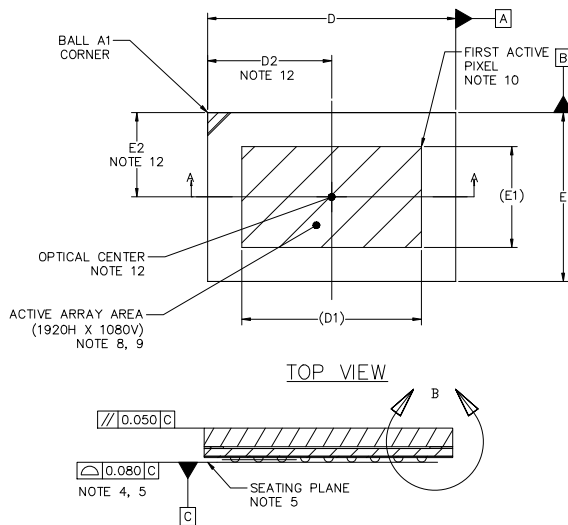


ODCSP53 5.31x3.61x0.63, 0.5P CASE 570AA ISSUE C

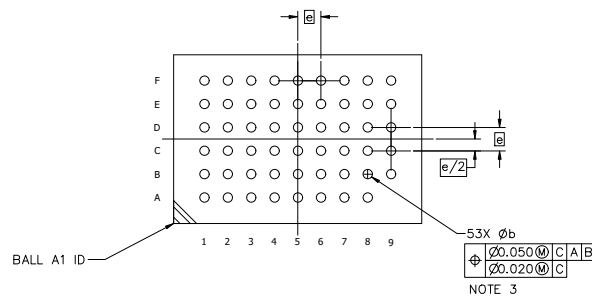
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NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS [mm].
3. SOLDER BALL DIAMETER IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. DATUM C, THE SEATING PLANE IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
6. GLASS: 0.400 THICKNESS; REFRACTIVE INDEX = 1.52.
7. AIR GAP BETWEEN GLASS AND PIXEL ARRAY: 0.040 THICKNESS.
8. PARALLELISM APPLIES ONLY TO THE ACTIVE ARRAY.
9. MAXIMUM ROTATION OF ACTIVE ARRAY RELATIVE TO DATUMS A AND B IS $\pm 0.1^\circ$.
10. REFER TO THE DEVICE DATA SHEET FOR TOTAL PIXEL ARRAY DEFINITIONS.
11. PACKAGE CENTER (X, Y) = (0.000, 0.000).
12. OPTICAL CENTER RELATIVE TO PACKAGE CENTER (X, Y) = (0.000, 0.000).

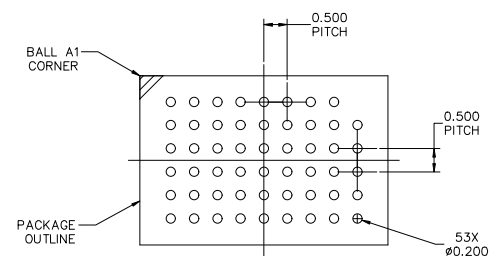
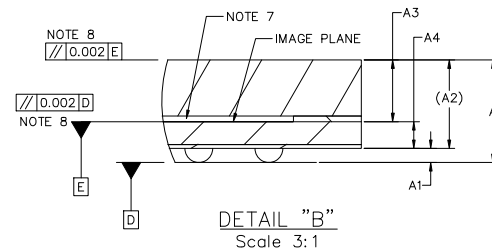


SECTION A-A



BOTTOM VIEW

MILLIMETERS			
DIM	MIN	NOM	MAX
A	---	---	0.762
A1	0.081	0.101	0.121
A2	0.631 REF		
A3	0.426	0.440	0.454
A4	0.180	0.191	0.202
b	0.184	0.204	0.224
D	5.290	5.315	5.340
D1	3.840 REF		
D2	2.633	2.658	2.683
E	3.590	3.615	3.640
E1	2.160 REF		
E2	1.783	1.808	1.833
e	0.500 BSC		
e/2	0.250 BSC		



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